## IN THE UNIT

6-24-05

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Application Number(s) or Patent number(s) (If this

document is being filed together with a new application, the

execution date of the application is: 11/22/04

4a. Patent Application No.(s) 11/005,458

Name: Semiconductor Energy Laboratory Co., Ltd. Address: 398, Hase, Atsugi-shi, Kanagawa-ken

Jun KOYAMA and Toshihiko SAITO

Nature of Conveyance

243-0036 Japan

Address

\_Security Agreement \_Change of Name

X Execution Date: 11/22/04

4b. Patent No.(s)

X Assignment Merger

Other

In re application of: Jun KOYAMA et al.

Serial No: 11/005,458 Filed: December 6, 2004 For: Semiconductor Device

Art Unit: Examiner:

Document ID No. 102902514

103029040

Atty Docket No: 0553-0430

## K OFFICE

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Edward D. Manzo, Esq.

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Chicago, Illinois 60606

Involved: \_1\_\_

Total Number of Applications and Patents
d: \_1

Total Fee (37 CFR 3.41): \$40.00
7a. X Enclosed
7b. X Authorized to be Charged to Deposit Account For Any Deficiency

Deposit Account Number: 50/1039 8. (A duplicate copy of this page is attached)

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Mark J. <u>Murphy</u>

Name of Person Signing

Date: June 21, 2005

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PATENT REEL: 017032 FRAME: 0616

CH \$40.00 501039 11005458

Attorney Docket

## ASSIGNMENT

I am the inventor (or one joint inventor) of a patent application that I am assigning. The patent application I am assigning is entitled <a href="SEMICONDUCTOR DEVICE">SEMICONDUCTOR DEVICE</a> which I executed herewith. If the patent application has already been filed, it received serial number and bears a filing date of
The Assignee and The Assignment. I assign my patent rights to <u>Semiconductor Energy Laboratory Co., Ltd.</u> a corporation organized according to the laws of <u>Japan</u> , having a place of business at <u>Japan Hase</u> , Atsugi-shi, <u>Kanagawa-ken 243-0036 Japan (hereinafter "the Assignee")</u> . The rights I assign are my entire right, title and interest in the invention or improvements disclosed in the patent application and any and all other applications for United States Letters Patent which I may file, either solely or jointly with others, on the invention or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof. I also assign to the Assignee all priority rights under the International Convention. I agree to execute, at the request of the Assignee, all documents in connection with any application for United States letters patent therefor.
Payment Received. I am making this assignment in consideration of One Dollar and other good and valuable consideration. Lacknowledge the receipt and sufficiency of the consideration.
Authorizations. I request the U.S. Commissioner of Patents and Trademarks to issue the Letters Patent to the Assignee. I authorize the attorney(s) of record in the application to insert in this assignment document the date and serial number of the application.
Further Acts. I agree, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. I agree to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee all rights therein, so that the Letters Patent will be held and enjoyed by the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me if this assignment had not been made.
Interference. In the event that any application or Letters Patent that I now assign becomes involved in interference, I agree to cooperate to the best of my ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.
Name: Jun KOYAMA Date
Name: Toshihiko SAITO  Date

PATENT REEL: 017032 FRAME: 0617

12-15- IN THE L. 102903 In re application of: Jun KOYAMA et al.  Serial No:	120604 Atty Docket No: 0553-0439
In re application of: Jun KOYAMA et al.	2014 — MARK-OFFICE iling Label No. EV 4594454
Filed: Herewith For: Semiconductor Device Art Unit: Examiner:	Date of Deposit December 6, 2004  I hereby certify that this correspondence is being deposited with the United States Postal Service Express Mail Post Office to Addressee* service under 37 CFR1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450  NMENT COVER SHEET Name: APMANDS CHARGE Cember 6, 2004 (typed or printed)  Signature
·	thereof. Total number of pages (with cover sheet): 2
1. Name of Conveying Party(ies):  Jun KOYAMA and Toshihiko SAITO  2a. Name and Address of Receiving Party(ies):  Name: Semiconductor Energy Laboratory Co., Ltd.  Address: 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan  2b. Name and Address of Receiving Party(ies):  Name: Address  3. Nature of Conveyance  X Assignment  Merger  Security Agreement  Change of Name  Other  X Execution Date: 11/22/04  4. Application Number(s) or Patent number(s) (If this document is being filed together with a new application, the execution date of the application is: 11/22/04  4a. Patent Application No.(s)  4b. Patent No.(s)	5. Name and Address of Party to Whom Correspondence Concerning Document Should be Mailed:  Edward D. Manzo, Esq.  COOK, ALEX, McFarron, Manzo, Cummings & Mehler, Ltd.  200 West Adams Street, Suite 2850  Chicago, Illinois 60606  6. Total Number of Applications and Patents Involved: 1  7. Total Fee (37 CFR 3.41): \$40.00  7a. X Enclosed  7b. X Authorized to be Charged to Deposit Account For Any Deficiency  8. Deposit Account Number: 50/1039  (A duplicate copy of this page is attached)  9. Statement and Signature:  To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
40. Faicili 140.(8)	Mark J. Murphy Name of Person Signing Signature Reg. No. 34,225 Date: December 6, 2004

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